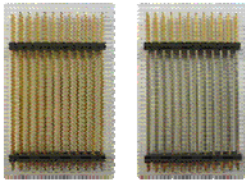




PCN - 13 011

Issue Date: February 25 2013

Product Name:	Bergstik		
	Bergstik Stacking Header		
Product Manager:	Franck CHAPOUILLY		
Subject:	Notification of Planned Change		
Distribution:	Global		
Type of Change:	Process Change		
Change Description:	 <p style="text-align: center;">Before After</p> <p>Higher selectivity without changing performances of the products – No more precious metal (will remain the Ni) between stacking height. Solder and mating plated sides will remain the same.</p>		
Reason for Change:	In order to allow continued competitive pricing to our customers in the wake of the highly volatile precious metals market.		
Affected Parts:	See list attached		
Effective Date of Change:	March	18	2013
Last Time Buy Date:	N/A	N/A	N/A
Last Disty Return Date:	N/A	N/A	N/A
Last Time Shipment Date	N/A	N/A	N/A
Datasheet Attached?	Yes	<i>Data sheets embedded.</i>	
Qual/Test Data Attached?	No		
Samples Availability Date:	February	25	2013
Available Alternatives?	No		
Questions?	<i>Contact your local FCI Representative, or</i>		
	<i>Franck CHAPOUILLY</i>		
	franck.chapouilly@fci.com		